PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3310676

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Chin-Chiang Chang	03/18/2015
Tao Cheng	03/18/2015

RECEIVING PARTY DATA

Name:	MEDIATEK INC.
Street Address:	No. 1, Dusing Rd. 1st, Science-Based Industrial Park
City:	Hsin-Chu
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14686783

CORRESPONDENCE DATA

Fax Number: (703)997-4517

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 3027291562

Email: Patent.admin.uspto.cr@naipo.com

Correspondent Name: WINSTON HSU **Address Line 1:** P.O.BOX 506

Address Line 4: MERRIFIELD, VIRGINIA 22116

ATTORNEY DOCKET NUMBER:	MTKP2117USA
NAME OF SUBMITTER:	SIBYL YU
SIGNATURE:	/SIBYL YU/
DATE SIGNED:	04/15/2015

Total Attachments: 4

source=2225608#page1.tif source=2225608#page2.tif source=2225608#page3.tif source=2225608#page4.tif

PATENT 503264058 REEL: 035409 FRAME: 0182

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention: INTEGRATED CIRCUIT STRESS RELEASING STRUCTURE

As the below named inventor, I here This declaration is directed to:	eby declare that:		
☑ The attached application, or			
☐ United States application nu	mber	filed on	, or
PCT international application	number	filed on	
The above-identified application was	made or authorized to	be made by me.	
I believe that I am the original invent application.	or or an original joint in	ventor of a claimed invention	in the
I hereby acknowledge that any willfuunder18 U.S.C. 1001 by fine or impr	il false statement made isonment of not more th	in this declaration is punishanan five (5) years, or both.	able
In consideration of the payment by	MEDIATEK INC.	having a	postal address of
No. 1, Dusing Rd. 1st, Science	e-Based Industrial	Park, Hsin-Chu 300, Tai	iwan, R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good an	o I of the sum of One Do id valuable consideration	ollar (\$ 1.00), the receipt of w	hich is hereby
I hereby sell, assign and transfer to A the entire right, title and interest in ar invention as above-identified applica- invention by the above application or substitutes, or extensions thereof, an	id to any and all improv tion and, in and to, all L any continuations, con	ements which are disclosed etters Patent to be obtained tinuation-in-part, divisions, re	in the for said
I hereby covenant that no assignmen entered into which would conflict with	it, sale, agreement or ei i this assignment;	ncumbrance has been or will	be made or
I further covenant that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to I and will testify as to the same in any interference, litigation proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal			
representatives any and all papers, ir maintain, issue and enforce said appl equivalents thereof which may be ned N WINTNESS WHEREOF, I have he	lication, said invention a cessary or desirable to	and said Letters Patent and s	hie
Note: An application data sheet (PTO/SB/14 or equivalent), including naming the entire nventive entity, must accompany this form. Use this form for each additional inventor.			

Page 1 of 4

NPO#MTK-P2117-USA:0 CUST#MTKI-14-271US

F#NPO-P0002E-US1201 DSB0-104U007875 MIRO4720 2018/03/18 16:14:33

Docket No MTKP2117USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor:

Chin-Chiang Chang

Date:

3/18/20/5

Signature:

Chin-Chiony Chang

Page 2 of 4

F#NPO-P0002E-US1201 DSB0-104U007875

PATENT REEL: 035409 FRAME: 0184

Docket No MTKP2117USA

COMBINE DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT

Title of Invention: INTEGRATED CIRCUIT STRESS RELEASING STRUCTURE

MTK04720 2015/03/18 16:14:32

As the below named inventor, I here This declaration is directed to:	by declare that:		
☑ The attached application, or			
☐ United States application nu	mber	filed on	, or
☐ PCT international application	number	filed on	
The above-identified application was	made or authorized to be made	e by me.	
I believe that I am the original inventapplication.	or or an original joint inventor of	a claimed invention in	n the
I hereby acknowledge that any willfu under18 U.S.C. 1001 by fine or impri	l false statement made in this de isonment of not more than five (eclaration is punishab 5) years, or both.	le
In consideration of the payment by	MEDIATEK INC.	having a po	ostal address of
No. 1, Dusing Rd. 1st, Science	e-Based Industrial Park, H	sin-Chu 300, Taiw	an, R.O.C.
(referred to as "ASSIGNEE"below) to acknowledged, andfor other good and	ol of the sum of One Dollar (\$ 1. d valuable consideration.	00), the receipt of wh	ich is hereby
I hereby sell, assign and transfer to A the entire right, title and interest in an invention as above-identified applicat invention by the above application or substitutes, or extensions thereof, an	nd to any and all improvements wittens to and, in and to, all Letters Pa any continuations, continuations	which are disclosed in itent to be obtained fo -in-part, divisions, rep	the r said
I hereby covenant that no assignmen entered into which would conflict with	t, sale, agreement or encumbra this assignment;	nce has been or will b	e made or
i further covenant that ASSIGNEE wil and documents relating to said invent known and accessible to I and will tes related thereto and will promptly exec	tion and said Letters Patent and stify as to the same in any interfe	legal equivalents as reference, litigation proce	may ha
representatives any and all papers, in maintain, issue and enforce said appl equivalents thereof which may be ned N WINTNESS WHEREOF, I have he	ication, said invention and said l sessary or desirable to carry out	etters Patent and so	id (Date of signing)
Note: An application data sheet (PTO, nventive entity, must accompany this	/SB/14 or equivalent), including form. Use this form for <u>each ad</u>	naming the entire ditional inventor.	

Page 3 of 4

NPO#MTK-P2117-USA:0 CUST#MTKI-14-271US

F#NPO-P0002E-US1201 DSB0-104U007875 30 \$015/03/38 1#:34:33

Docket No MTKP2117USA

LEGAL NAME OF INVENTOR(ASSIGNOR)

Inventor: Tao Cheng

Date:

3/18:15

Signature:

Jag Ohero

Page 4 of 4

F#NPO-P0002E-US1201 DSB0-104U007875

PATENT REEL: 035409 FRAME: 0186

NPO#MTK-P2117-USA:0 CUST#MTKI-14-27IUS

RECORDED: 04/15/2015